

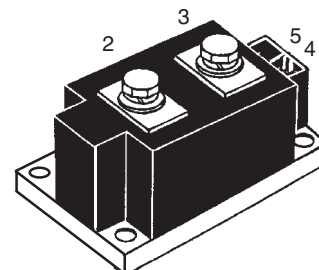
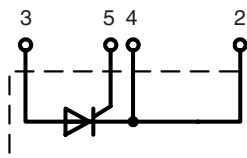
High Power Single Thyristor Module

$$I_{TRMS} = 928 \text{ A}$$

$$I_{TAV} = 600 \text{ A}$$

$$V_{RRM} = 1600\text{-}2200 \text{ V}$$

V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V	Type
1700	1600	MCO 600-16io1
1900	1800	MCO 600-18io1
2100	2000	MCO 600-20io1
2300	2200	MCO 600-22io1



Symbol	Conditions	Maximum Ratings	
I_{TRMS}	$T_{VJ} = T_{VJM}$	928	A
I_{TAV}	$T_C = 85^\circ\text{C}; 180^\circ \text{ sine}$	600	A
I_{TSM}	$T_{VJ} = 45^\circ\text{C}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	15000 A
		$t = 8.3 \text{ ms (60 Hz)}$	16000 A
	$T_{VJ} = T_{VJM}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	13000 A
		$t = 8.3 \text{ ms (60 Hz)}$	14400 A
I^2t	$T_{VJ} = 45^\circ\text{C}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	1125000 A ² s
		$t = 8.3 \text{ ms (60 Hz)}$	1062000 A ² s
	$T_{VJ} = T_{VJM}; V_R = 0$	$t = 10 \text{ ms (50 Hz)}$	845000 A ² s
		$t = 8.3 \text{ ms (60 Hz)}$	813000 A ² s
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}; f = 50\text{Hz}; I_G = 1\text{A}$	repetitive, $I_T = 960\text{A}$	100 A/ μs
	$V_D = \frac{2}{3} V_{DRM}; t_p = 200 \mu\text{s}; di_G/dt = 1 \text{ A}/\mu\text{s}$	non repetitive, $I_T = I_{TAVM}$	500 A/ μs
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}; V_{DR} = \frac{2}{3} V_{DRM}; R_{GK} = \infty; \text{method 1 (linear voltage rise)}$	1000	V/ μs
P_{GM}	$T_{VJ} = T_{VJM}; I_T = I_{TAVM}; t_p = 30 \mu\text{s}$	120	W
		60	W
P_{GAV}		30	W
V_{RGM}		10	V
T_{VJ}		-40...140	$^\circ\text{C}$
T_{VJM}		140	$^\circ\text{C}$
T_{stg}		-40...125	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS; $t = 1 \text{ min}$	3000	V~
	$I_{ISOL} \leq 1 \text{ mA}; t = 1 \text{ s}$	3600	V~
M_d	Mounting torque (M6)	4.5-7/40-62	Nm/lb.in.
	Terminal connection torque (M8)	11-13/97-115	Nm/lb.in.
Weight	Typical including screws	650	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

Features

- Direct copper bonded Al_2O_3 -ceramic with copper base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL applied
- Keyed gate/cathode twin pins

Applications

- Motor control, softstarter
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Solid state switches

Advantages

- Improved temperature and power cycling
- Reduced protection circuits

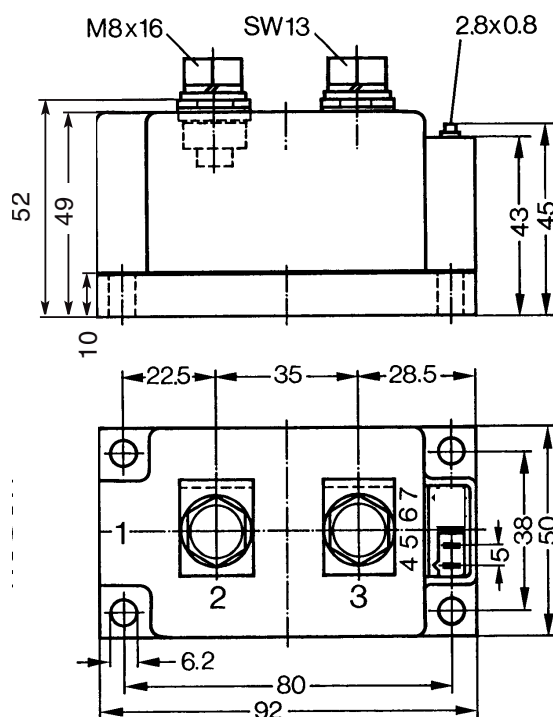
Symbol	Conditions	Characteristic Values	
I_{RRM}	$T_{VJ} = T_{VJM}; V_R = V_{RRM}$	60	mA
V_T	$I_T = 600 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.15	V
V_{T0}	For power-loss calculations only ($T_{VJ} = T_{VJM}$)	0.77	V
r_T		0.42	mΩ
V_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	2	V
	$T_{VJ} = -40^\circ\text{C}$	3	V
I_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$	300	mA
	$T_{VJ} = -40^\circ\text{C}$	400	mA
V_{GD}	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM}$	0.25	V
I_{GD}	$T_{VJ} = T_{VJM}; V_D = \frac{2}{3} V_{DRM}$	10	mA
I_L	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; t_p = 30 \mu\text{s}$ $di_G/dt = 1 \text{ A}/\mu\text{s}; I_G = 1 \text{ A}$	400	mA
I_H	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	300	mA
t_{gd}	$T_{VJ} = 25^\circ\text{C}; V_D = \frac{1}{2} V_{DRM}$ $di_G/dt = 1 \text{ A}/\mu\text{s}; I_G = 1 \text{ A}$	2	μs
t_q	$T_{VJ} = T_{VJM}; V_R = 100 \text{ V}; V_D = \frac{2}{3} V_{DRM}; t_p = 200 \mu\text{s}$ $dv/dt = 50 \text{ V}/\mu\text{s}; I_T = 500 \text{ A}; -di/dt = 10 \text{ A}/\mu\text{s}$	typ. 350	μs
R_{thJC}	DC current	0.065	K/W
R_{thJK}	DC current	0.085	K/W
d_s	Creep distance on surface	12.7	mm
d_A	Strike distance in air	9.6	mm
a	Maximum allowable acceleration	50	m/s ²

Optional accessories for modules

Keyed Gate/Cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180 L** (L = Left for pin pair 4/5) { UL 758, style 1385, File E 38136,
CSA class 5851, guide 460-1-1, appl. 41234

Dimensions in mm (1 mm = 0.0394")



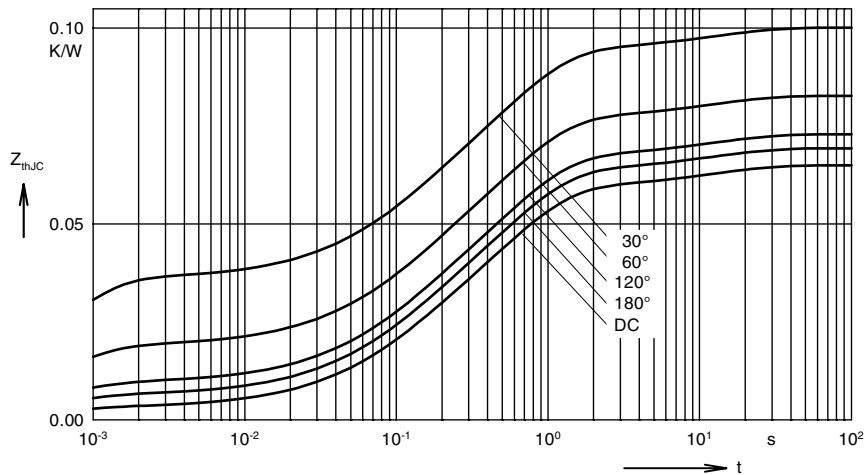


Fig. 1 Transient thermal impedance junction to case (per thyristor)

R_{thJC} for various conduction angles d :

d	R_{thJC} (K/W)
DC	0.065
180°	0.069
120°	0.073
60°	0.083
30°	0.1

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0031	0.00054
2	0.0168	0.098
3	0.039	0.54
4	0.0061	12

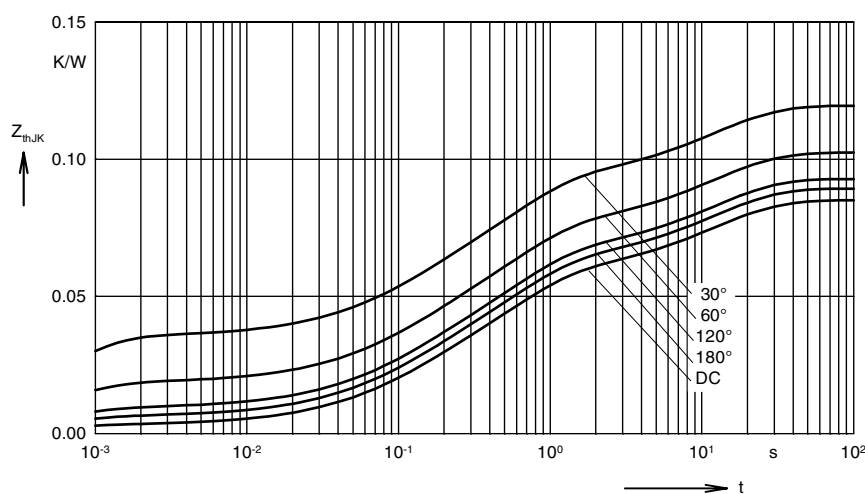


Fig. 2 Transient thermal impedance junction to heatsink (per thyristor)

R_{thJK} for various conduction angles d :

d	R_{thJK} (K/W)
DC	0.085
180°	0.089
120°	0.093
60°	0.102
30°	0.119

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0031	0.00054
2	0.0168	0.098
3	0.039	0.54
4	0.0061	12
5	0.02	12